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(54) TRANSISTOR CIRCUIT, DISPLAY PANEL AND ELECTRONIC APPARATUS

(57) A transistor circuit (100) including a driving transistor (110) where conductance between a source and a drain is controlled in response to voltage, and a compensating transistor (120) where a gate is connected to one of a source and a drain and wherein the compensating transistor is connected so as to supply input signals to the gate of the driving transistor through the source and drain. In a transistor circuit where conductance control in a driving transistor is carried out in response to the voltage of input signals, it is possible to control the conductance by using input signals of a relatively low voltage and a variance in threshold characteristics of driving transistors is compensated. With this transistor circuit, a display panel that can display picture images with reduced uneven brightness is achieved.

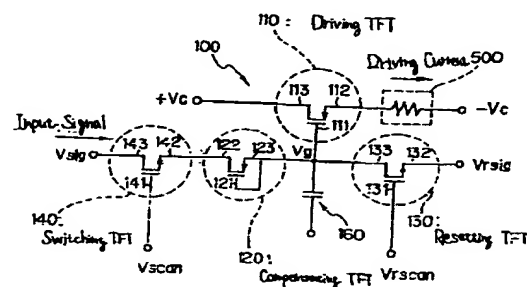


Fig. 1

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Description

Technical Field

[0001] This invention relates to the technical field of transistor circuits including a plurality of transistors such as thin-film transistors (mentioned as TFT hereafter), field effect transistors and bipolar transistors, and particularly relates to the technical field of transistor circuits including driving transistors for controlling driving current - by controlling conductance between a source and a drain in response to voltage supplied to a gate - that is supplied to a driven element such as a current-controlled (current-driven) element through the source and the drain.

Background Art

[0002] Generally, the voltage/current characteristics and thresholds of transistors tend to vary, depending on various conditions such as the quality and thickness of semiconductor films, impurity concentration and diffusion areas, the quality and thickness of gate insulating films, etc., operating temperature and the like. In the case of bipolar transistors having crystal silicon, the variance of thresholds is relatively small, but in the case of TFTs, the variance is usually large. Particularly, in the case of TFTs formed on a TFT array substrate in a wide range in a plurality in a display panel such as a liquid crystal panel, an EL panel, etc., the variance in voltage/current characteristics and thresholds often becomes extremely large. For instance, when such TFTs are manufactured so as to set the threshold at about 2V (+2V in the case of N channel, and -2V in the case of P channel), the variance is sometimes about several \pm V.

[0003] In the case of a voltage-controlled (voltage-driven) type for controlling the voltage of picture elements made of liquid crystals or the like such as a so-called TFT liquid crystal panel, the variance of voltage/current characteristics and thresholds of driving TFTs that are applied to each picture element is not likely to be a problem. In other words, in this case, even if there is a slight variance in the voltage/current characteristics and thresholds of TFTs, contrast and brightness of each picture element can be controlled at high precision by increasing the precision of voltage supplied to each picture element from outside through the TFTs only if there is enough switching time. Therefore, even in the case of a TFT liquid crystal panel for display wherein contrast and brightness at each picture element are regarded as important, etc., high grade picture images can be displayed, etc. by TFTs with a relatively large variance of voltage/current characteristics and thresholds.

[0004] On the other hand, display panels have been recently developed that include current-controlled light-emitting elements, such as a self light-emitting organic

ELs to change brightness in response to current supply, at picture elements; and they have received attention as display panels that can display picture images without back light and reflected light, consuming less power, being less dependent on the angle of view, and are sometimes flexible. Even in this EL panel, a driving TFT is used at each picture element for driving an active matrix. For instance, it is constructed so as to control (change) driving current supplied to an EL element from power source wiring connected to a source in response to the voltage of data signals applied to a gate, by connecting the drain of a driving TFT to the EL element through a hole-injecting electrode. Using a driving TFT as mentioned above, driving current flowing to an EL element can be controlled by controlling conductance between a source and a drain in response to the voltage change of input signals, so that brightness at each picture element can be changed for picture image display and the like.

[0005] However, particularly in the case of the current-controlled element such as the EL panel mentioned above, the variance of voltage/current characteristics and thresholds tends to be a problem in the driving TFT at each picture element. In other words, in this case, even if the voltage precision of data signals supplied to the driving TFTs from outside is enhanced to some extent, the variance of voltage/current characteristics and thresholds in the driving TFTs appears directly as the variance of driving current to data signals, thus reducing the precision of the driving current. As a result, the brightness at each picture element is likely to vary in accordance with the variance in thresholds of the driving TFTs. Moreover, especially with current manufacturing techniques of low temperature polysilicon TFTs, voltage/current characteristics and thresholds vary considerably; thus, this problem is in practicality, extremely serious.

[0006] If each TFT is manufactured so as to reduce the variance of voltage/current characteristics and thresholds in consideration of this problem, the yield will decline and, particularly in the case of an apparatus with a display panel having a plurality of TFTs, the yield will decrease a great extent, thus opposing a general goal - lower costs. Or, it is almost impossible to manufacture TFTs that can lower such a variance. Moreover, even if a circuit for compensating the variance of voltage/current characteristics and thresholds at each TFT is installed separately, the apparatus will be complex and large, and moreover, the consumption of electric power will increase. Particularly, in the case of a display panel wherein a plurality of TFTs are arranged at high density, the yield will decline again or it will be difficult to satisfy current demands such as lower power consumption and miniaturization and lightening of an apparatus.

Disclosure of Invention

[0007] This invention is carried out in consideration

of the above-noted problems, and aims to provide transistor circuits for controlling conductance in driving transistors in response to the voltage of input signals, the conductance of which can be controlled by relatively small input signals and that can compensate for the variance of voltage/current characteristics and thresholds of driving transistors with somewhat smaller power consumption by using a relatively small number of transistors, and a display panel and an electronic apparatus using the same.

[0008] In this invention, the following transistor circuits according to the first to tenth aspects are provided.

[0009] First, a transistor circuit according to a first aspect of the invention is characterized in that it includes a driving transistor having a first gate, a first source and a first drain wherein conductance between the first source and first drain is controlled in response to the voltage of input signals supplied to the first gate, and a compensating transistor having a second gate, a second source and a second drain wherein the second gate is connected to one of the second source and second drain, and wherein the compensating transistor is connected to the first gate in an orientation so as to supply the input signals to the first gate through the second source and second drain and to allow the first gate to move electric charge into a direction to lower the conductance.

[0010] According to the above-noted transistor circuit of the first aspect of the invention, one of the second source and second drain of the compensating transistor is connected to the first gate of the driving transistor, and input signals are supplied to the first gate of the driving transistor through this second source and second drain. Then, at the driving transistor, the conductance between the first source and first drain is controlled in response to the voltage of input signals supplied to the first gate. Herein, the compensating transistor has the second gate connected to the second drain, and is connected to the first gate in an orientation to allow the first gate to move electric charge into a direction to lower the conductance between the first source and first drain. In other words, the compensating transistor has diode characteristics; and when the driving transistor is, for example, an N-channel type, current can be carried from the first gate into the direction of an input signal source. Or, when the driving transistor is a P-channel type, current can be carried from an input signal source to the direction of the first gate.

[0011] Therefore, as input signals are supplied to the transistor circuit, the gate voltage of the first gate, compared with the voltage of input signals at the time of being input to the compensating transistor, rises to the side of increasing the conductance of the driving transistor only by a threshold level of the compensating transistor. As a result, in order to obtain preferable conductance in the driving transistor, input signals of voltage that is lower only by a threshold (voltage) level of the compensating transistor, instead of the gate voltage

corresponding to the conductance, can be supplied through the compensating transistor. In this way, since the gate voltage in response to input signals can rise only by a threshold (voltage) of the compensating transistor, equivalent conductance control can be carried out by the lower voltage of input signals compared with the case of no compensating transistor.

[0012] These input signals are generally at a high frequency relative to other signals; and the consumption of electric power can be reduced significantly if lower input signals can be used.

[0013] Moreover, setting gate voltage at the first gate by increasing the voltage of input signals from the compensating transistor as mentioned above indicates that, when seen as a transistor circuit as a whole, the threshold of input signals to driving current flowing through a source and a drain whose conductance is controlled in the driving transistor is lower than the threshold voltage of the driving transistor only by the threshold voltage of the compensating transistor as a voltage increase from the input voltage to the gate voltage. In other words, within the threshold of input voltage to driving current, the threshold of the compensating transistor and the threshold of the driving transistor are offset from each other. Therefore, by making the threshold characteristics and the voltage/current characteristics of both transistors similar to each other, it is possible to set the threshold of input signals to driving current to zero.

[0014] Moreover, by offsetting the threshold of the driving transistor and the threshold of the compensating transistor in the transistor circuit as a whole as mentioned above, the threshold of input signals can be set closer to a constant level (zero) without depending on the level of threshold of the driving transistor. In other words, when a plurality of transistor circuits is prepared by using many driving transistors with different thresholds, a difference in thresholds between transistor circuits is smaller than (or is ideally almost the same as) a difference in the thresholds of driving transistors by setting the thresholds of the driving transistor and the compensating transistor in each transistor circuit close to each other (ideally equal to each other). Thus, in preparing a plurality of transistor circuits, a plurality of transistor circuits with almost or completely no variance in thresholds can be provided even when many driving transistors with many different thresholds are used.

[0015] A transistor circuit according to a second aspect of the invention, in the transistor circuit according to the first aspect mentioned above, is characterized in that it has a resetting means for supplying reset signals - having voltage giving higher conductance than the maximum conductance controlled in response to the input signals - to a first gate before the input signals are supplied.

[0016] According to the above-noted transistor circuit of the second aspect of the invention, before input signals are supplied to the first gate of a driving transistor (or after the input signals are supplied before the

next input signals are supplied), reset signals - having a voltage giving a higher conductance than the maximum conductance of the driving transistor controlled in response to input signals - are supplied to this first gate by the resetting means. As a result, the gate voltage of the driving transistor can be set constant without depending on the level of voltage of input signals; and moreover, it becomes possible to supply input signals to the first gate through the compensating transistor which is connected to the first gate in an orientation to permit electric charge to move into a direction so as to lower conductance after resetting.

[0017] A transistor circuit according to a third aspect of the invention, in the above-noted transistor circuits according to any of the first and second aspects, is characterized in that the reset signals are set at a voltage higher than the maximum voltage of input signals by a threshold voltage level of the compensating transistor.

[0018] According to the above-mentioned transistor circuit of the third aspect of the invention, reset signals having a higher voltage than input signals are supplied to the first gate of the driving transistor by the resetting means. Moreover, the voltage of these reset signals is set higher than the maximum voltage of the input signals by a threshold voltage of the compensating transistor, so that a voltage higher than the voltage of the input signals by a threshold voltage level of the driving transistor can be always supplied to the first gate of the driving transistor through the compensating transistor, without being dependent on the level of voltage of input signals or thresholds of the driving transistor, when input signals are input after resetting.

[0019] A transistor circuit according to a fourth aspect of the invention, in the transistor circuit according to the second aspect mentioned above, is characterized in that it includes a resetting transistor wherein the resetting means has a third gate, a third source and a third drain, wherein one of the third source and the third drain is connected to the first gate, and wherein the reset signals are supplied to the first gate through the third source and third drain after reset timing signals are supplied to the third gate before the supply of the input signals.

[0020] According to the above-noted transistor circuit of the fourth aspect of the invention, when reset timing signals are supplied to the third gate of the resetting transistor, reset signals are supplied to the first gate of the driving transistor through the third source and third drain by the resetting transistor. As a result, the gate voltage of the driving transistor can be reset at a constant by the timing of supplying reset timing signals. Therefore, the operations that are explained for the second transistor circuit become possible.

[0021] A transistor circuit according to a fifth aspect of the invention, in the transistor circuit according to any one of the first to the fourth aspects mentioned above, is characterized in that the driving transistor and the com-

pensating transistor are the same type of transistors.

[0022] According to the transistor circuit of the fifth aspect of the invention mentioned above, the driving transistor and the compensating transistor are the same type of transistors, but the "same type" means that the conductive type of transistors is the same herein. For instance, when the driving transistor is an N channel type, the compensating transistor is also the N channel type. With the driving transistor as a P channel type, the compensating transistor is also the P channel type. Therefore, the threshold of the compensating transistor and the threshold of the driving transistor become almost equal to each other, so that these thresholds are offset from each other in the transistor circuit. As a result, it becomes possible to carry out conductance control by setting the threshold of input signals to driving current almost to zero.

[0023] Also, by providing the same channel width of transistors, design values including a channel length, device structures, process conditions, etc. to both driving transistor and compensating transistor, more complete compensation becomes possible.

[0024] A transistor circuit according to the sixth aspect of the invention, in the transistor circuit according to any of the above-noted first to the fifth aspects, is characterized in that the circuit further includes a switching transistor having a fourth gate, a fourth source and a fourth drain, and wherein the transistor is connected so as to supply the input signals to the compensating transistor through the fourth source and fourth drain when switching timing signals are supplied to the fourth gate.

[0025] According to the above-noted transistor circuit of the sixth aspect, when switching timing signals are supplied to the fourth gate of the switching transistor, input signals are supplied to the compensating transistor through the fourth source and fourth drain of the switching transistor. As a result, input signals can be supplied to the driving transistor by the timing of supplying switching timing signals.

[0026] A transistor circuit according to a seventh aspect of the invention, in the transistor circuit according to any of the above-noted first to sixth aspects, is characterized in that it further includes a storage capacitor connected to the first gate.

[0027] According to the transistor circuit of the seventh aspect, when input signals are supplied to the first gate, the voltage is held by the storage capacitor connected to the first gate. Therefore, even when input signals are supplied only for a fixed period, the voltage at the first gate can be held over a longer period than the fixed period.

[0028] Also, even when there is leakage current in the switching transistor through the compensating transistor, it becomes possible to reduce the fluctuation of electric potential applied to the first gate.

[0029] A transistor circuit according to an eighth aspect of the invention, in the transistor circuit according

to any of the above-noted first to seventh aspects, is characterized in that the transistors consist of thin-film transistors formed on the same substrate respectively.

[0030] According to the transistor circuit of the eighth aspect, the effect of voltage/current characteristics and threshold characteristics of the driving thin-film transistor, which is formed on the same substrate, on driving current can be compensated by the compensating thin-film transistor. Particularly, as both thin-film transistors are formed on the same substrate in the same thin-film forming process, the characteristics between both transistors become similar, so that it becomes possible to provide a plurality of transistor circuits with little variance in voltage/current characteristics and threshold characteristics on the same substrate.

[0031] A transistor circuit according to a ninth aspect of the invention, in the transistor circuit according to any of the above-noted first to seventh aspect, is characterized in that the transistors consist of bipolar transistors respectively wherein the gate, source and drain correspond to a base, a collector and an emitter respectively.

[0032] According to the transistor circuit of the ninth aspect, the effect of voltage/current characteristics and threshold characteristics of the driving bipolar transistor on driving current can be compensated by the compensating bipolar transistor. Particularly, as both bipolar transistors are manufactured in the same manufacturing process, the degree of characteristic similarity between both transistors generally increases, so that it becomes possible to provide a plurality of transistor circuits with little variance in voltage/current characteristics and threshold characteristics.

[0033] A transistor circuit according to a tenth aspect of the invention, in the transistor circuit according to any of the above-noted first to ninth aspects, is characterized in that the input signals are voltage signals where voltage is controlled by an input signal source and that the driving transistor, wherein one of the first source and first drain is connected to a current-controlled element, controls electric current flowing to the current-controlled element by controlling the conductance.

[0034] According to the transistor circuit of the tenth aspect of the invention, as the voltage signals where voltage is controlled by an input signal source are supplied through the compensating transistor as input signals, conductance between the first source and first drain is controlled in response to the change in voltage of these voltage signals in the driving transistor. As a result, the current-controlled element, connected to one of the first source and first drain, is current-controlled. Thus, it becomes possible to current-drive the current-controlled element by the input signals of a relatively low voltage. Moreover, it becomes possible to current-control a plurality of current-driven elements with good precision in response to voltage signals without being dependent on the variance in voltage/current characteristics and thresholds between a plurality of driving tran-

sistors.

[0035] According to this invention, a display panel is provided which is characterized in that it includes the above-noted tenth transistor circuits of this invention respectively and has a plurality of picture elements arranged in a matrix condition, and that current-controlled light-emitting elements are provided respectively to the plurality of picture elements as the current-controlled elements.

[0036] According to the display panel, as input signals are provided through the compensating transistor at each picture element, the current-controlled light-emitting elements are current-controlled in response to the voltage of these input signals by the driving transistor, so that the brightness of the current-controlled light-emitting elements can be controlled with good precision without being dependent on the variance in voltage/current characteristics and threshold characteristics among the driving transistors and that the unevenness of brightness can be reduced over the entire screen display area of the display panel. Moreover, by increasing the gate voltage of the driving transistor with the compensating transistor, the current-controlled light-emitting elements can be controlled by the input signals of a relatively low voltage.

[0037] According to this invention, an electronic apparatus having the above-noted display panel is provided.

[0038] According to such an electronic apparatus, since it has the above-described display panel, an electronic device can be realized that has little unevenness in brightness over the entire surface of the display panel and can be driven at a relatively low voltage.

Brief Description of Drawings

[0039]

Fig. 1 is a circuit diagram in one embodiment of a transistor circuit of the invention.

Fig. 2 (A) is a timing chart of various signals in a transistor circuit using p-channel transistors, and Fig. 2 (B) is a timing chart of various signals in a modified embodiment of the transistor circuit using n-channel transistors.

Fig. 3 (A) is a characteristic diagram showing the threshold characteristics in a comparative example having a driving TFT, and Fig. 3 (B) is a characteristic diagram showing the threshold characteristics in the embodiment having a compensating TFT and a driving TFT.

Fig. 4 is a characteristic diagram showing various cases of the fluctuation in driving current I_d in response to the variance ΔV_{th} of thresholds.

Fig. 5 (A) is a timing chart showing step-down voltage operations by a compensating TFT when the reset signal V_{rsig} is set at 5V in the embodiment, and Fig. 5 (B) is a timing chart showing step-down

voltage operations by the compensating TFT when the reset signal V_{rsig} is set at 0V.

Fig. 6 is a circuit diagram in another embodiment of a transistor circuit of the invention.

Fig. 7 is a planar view showing an entire structure in one embodiment of a display panel of the invention. Fig. 8 is a planar view of one picture element of the display panel of Fig. 7.

Fig. 9 (A) is a cross-sectional view taken on line A-A' of Fig. 8; Fig. 9 (B) is a cross-sectional view taken on line B-B'; and Fig. 9 (C) is a cross-sectional view taken on line C-C'.

Fig. 10 is a circuit diagram of adjoining four picture elements in the display panel of Fig. 7.

Fig. 11 is a block diagram showing a schematic structure in one embodiment of an electronic apparatus of this invention.

Fig. 12 is a front view of a personal computer as an example of an electronic apparatus.

Fig. 13 is a perspective diagram showing a liquid crystal device using a TCP as another example of an electronic apparatus.

Best Mode for Carrying out the Invention

[0040] The operation of this invention and other benefits will be made clear by the embodiments explained below. The embodiments of this invention will be explained below with reference to drawings.

(Transistor Circuit)

[0041] First, the embodiment of a transistor circuit of this invention is explained with reference to Fig. 1 and Fig. 2. Fig. 1 is a circuit diagram of a transistor circuit in the embodiment, and Fig. 2 (A) and Fig. 2 (B) are timing charts showing the timing and voltage of various signals in the transistor circuit respectively.

[0042] In Fig. 1, a transistor circuit 100 comprises a driving TFT 110 (P channel type), a compensating TFT 120 (P channel type), a resetting TFT 130 (N channel type) and a switching TFT 140 (N channel type). The structure of each transistor will be sequentially explained below.

[0043] First, the driving TFT 110, as an example of driving transistors, is constructed so as to control conductance between a source 112 and a drain 113 in response to gate voltage V_g applied to a gate 111 based on input signals supplied through the switching TFT 140 and the compensating TFT 120.

[0044] The compensating TFT 120, as an example of compensating transistors, has its gate 121 connected to one of a source 122 and a drain 123 (drain 123 in the case of Fig. 1). In other words, the compensating TFT 120 is so-called diode-connected. Moreover, the compensating transistor 120 is connected to the gate 111 in an orientation so as to supply input signals to the gate 111 through the source 122 and the drain 123 and to

allow the gate 111 to move electric charge into a direction to lower conductance (the side of drain 123 in Fig. 1).

[0045] The resetting TFT 130, an example of resetting means, has one of a source 132 and a drain 133 (drain 133 in Fig. 1) connected to the gate 111, and reset signals at voltage V_{rsig} (called reset signals V_{rsig} hereafter) are supplied to the gate 111 through the source 132 and the drain 133 when reset scanning signals at voltage V_{rscan} (called reset scanning signals V_{rscan} hereafter) are supplied to the gate 131 as an example of reset timing signals before the supply of input signals V_{sig} .

[0046] Also, the switching TFT 140, an example of switching transistors, is connected between an input signal source and the compensating TFT 120 so as to supply input signals at voltage V_{sig} (called input signals V_{sig} hereafter) to the compensating TFT 120 through a source 142 and a drain 143 when scanning signals at voltage V_{scan} (called scanning signals V_{scan} hereafter) are supplied to the gate 141 as an example of switching timing signals.

[0047] Moreover, one terminal of a current-controlled (current-driven) element 500 such as an EL element is connected to the source 112 of the driving transistor 110; and negative power source $-V_c$ with a predetermined electric potential is connected to another terminal of this current-controlled element 500. In addition, positive power source $+V_c$ with a predetermined electric potential is connected to the drain 113 of the driving transistor 110. Therefore, when conductance between the source 112 and the drain 113 is controlled at the driving transistor 110, driving current I_d flowing through the current-controlled element 500 is controlled (in other words, driving current I_d varies in response to conductance fluctuation).

[0048] Furthermore, a storage capacitor 160 is connected to the gate 111 of the driving transistor 110. As a result, the once applied gate voltage V_g is held by the storage capacitor 160.

[0049] Then, the operation of the transistor circuit 100 constructed as above is explained with reference to Fig. 1 along with Fig. 2 and Fig. 3.

[0050] As shown in Fig. 2 (A) (this figure shows that a P channel type TFT is applied to both driving TFT 110 and compensating TFT 120), the resetting TFT 130 will be in conductance when reset scanning signals V_{rscan} are input to the resetting TFT 130; and resetting signals V_{rsig} are then supplied to the gate 111 of the driving TFT 110, so that the gate voltage V_g of the gate 111 becomes almost the same as the voltage V_{rsig} of these reset signals V_{rsig} . As a result, without being dependent on the level of voltage of input signals V_{sig} , the gate voltage V_g of the driving TFT 110 can be reset at a fixed voltage (in other words, voltage V_{rsig}) by the timing of supplying reset scanning signals V_{rsig} .

[0051] Then, as scanning signals V_{scan} are supplied to the switching TFT 140 after this resetting period,

the switching TFT 140 will be in conductance and the driving signals V_{sig} are supplied to the gate 111 of the driving TFT 110 through the compensating TFT 120. In this embodiment, the gate 121 is connected (in other words, diode-connected) to the drain 123 particularly in the compensating TFT 120 herein, so that gate voltage V_g in the driving TFT 110 - the P channel type TFT that will be in conductance by the application of negative voltage to the gate 111 - is made lower than the voltage V_{sig} of data signals V_{sig} to the negative voltage side only by a threshold voltage V_{th2} level of the compensating TFT 120. Then, the gate voltage V_g lowered as mentioned above will be held in a driving period by the storage capacitor 160 even after the supply of scanning signals V_{scan} and input signals V_{sig} is stopped.

[0052] In addition, the period in which gate voltage V_g becomes the voltage V_{rsig} of reset signals V_{rsig} is sufficient for the resetting period. Thus, the driving period can be set much longer than the resetting period, so that even if the driving TFT 110 is in conductance by resetting signals V_{rsig} in the resetting period, the effect on driving current I_d flowing through the source 112 and the drain 113 of the driving TFT 110 in this period can be minimized to a negligible degree.

[0053] As described above, according to this embodiment, gate voltage V_g relative to input signals V_{sig} can rise only by a threshold voltage V_{th2} level of the compensating TFT 120, so that it becomes possible to carry out the same conductance control in the driving TFT 110 by using a lower input signal voltage V_{sig} compared with the case with no compensating TFT 120.

[0054] Also, Fig. 2 (B) is a timing chart where an N channel type TFT is applied to both driving TFT 110 and compensating TFT 120. In this case, the gate voltage V_g at the driving TFT 110 - N channel type TFT that will be in conductance by the application of positive voltage to the gate 111 - is made higher than the voltage V_{sig} of input signals V_{sig} to the positive voltage side only by a threshold V_{th2} level of the compensating TFT 120 after being set at the voltage V_{rsig} of reset signals V_{rsig} during resetting.

[0055] If input signals V_{sig} are directly input to the driving TFT 110 without going through compensating TFT 120 - in other words, when the voltage V_{sig} of input signals V_{sig} is the same as the gate voltage V_g , driving current I_d rises from a threshold voltage V_{th1} of the driving TFT 110 as shown in Fig. 3 (A) (in this case, the driving TFT 110 is an N channel). For example, if the design standard value of this threshold voltage V_{th1} is 2V, a variance in thresholds will be about \pm several V. Then, a variance in threshold voltage V_{th1} in the driving TFT 110 will appear directly as a variance in driving current I_d .

[0056] On the contrary, in this embodiment, since input signals V_{sig} are input to the driving TFT 110 through the compensating TFT 120 - in other words, when the voltage V_{sig} of input signals V_{sig} is raised only by the threshold voltage V_{th2} level of the compen-

sating TFT 120 to be gate voltage V_g , the threshold voltage V_{th2} of the compensating TFT 120 and the threshold voltage V_{th1} of the driving TFT 110 are offset as shown in Fig. 3 (B) (in this case, both driving TFT 110 and compensating TFT 120 are N channels) and the threshold voltage V_{th} of input signals V_{sig} to the entire transistor circuit 100 then becomes near zero. Moreover, particularly when both threshold voltages V_{th1} and V_{th2} are nearly the same, this threshold voltage V_{th} becomes almost zero. Thus, equalizing threshold voltage V_{th1} to V_{th2} can be relatively easily carried out e.g., by applying the same conductive type TFT to the driving TFT 110 and the compensating TFT 120 in an adjoining position on the same semiconductor substrate.

[0057] As constructed above, in both TFTs, the thickness of thin gate insulating films, semiconductor films, etc., the planar shapes of each component such as a channel length, impurity concentration in regions for forming channels, source regions and drain regions, temperature during operation and the like can easily become the same, so that the threshold voltage V_{th1} and V_{th2} of both TFTs can be completely or almost completely equalized. In addition, in making threshold characteristics similar, it is better to make channel lengths the same, but channel widths do not have to be the same.

[0058] Thus, according to this embodiment, by setting the threshold characteristics and voltage/current characteristics of the driving TFT 110 and the compensating TFT 120 close (ideally the same), it is possible to set the threshold voltage V_{th} of input signals V_{sig} to driving current I_d to near zero (ideally equal to zero).

[0059] Moreover, as seen from Fig. 3 (A) and Fig. 3 (B), in manufacturing a plurality of transistor circuits 100, even if threshold voltage V_{th1} at each driving TFT 110 varies from each other, the threshold voltage V_{th} of each transistor circuit 100 is almost zero by the operation of each compensating TFT 120 without being dependent on the level of this threshold voltage V_{th1} . In other words, a plurality of transistor circuits 100 with a constant threshold voltage V_{th} can be manufactured. This is particularly useful for a display panel and the like where a variance in threshold voltage V_{th} among a plurality of transistor circuits 100 is a problem as described below. Also, it is much easier to equalize the threshold voltage V_{th1} of the driving TFT 110 and the threshold voltage V_{th2} of the compensating TFT 120 that are a mutually adjoining pair at each transistor circuit 100 than to equalize the threshold voltage V_{th1} of two driving TFTs 110 that are separately arranged with a gap therebetween, so that it is possible to say that the structure of compensating threshold voltage V_{th1} in each transistor circuit 100 by the compensating TFT 120 is extremely effective, so as to reduce a variance of threshold voltage V_{th} among a plurality of transistor circuits 100 from each other.

[0060] As described above, according to this

embodiment, even if a plurality of driving TFTs 110 with different threshold voltage V_{th1} from a threshold voltage (for example, 2.5V) as a design standard level is used in preparing a plurality of transistor circuits 100, it becomes possible to provide a plurality of circuits 100 with little or no variance in threshold voltage V_{th} . Therefore, the requirements for TFTs regarding voltage/current characteristics are made easy, and it becomes possible to improve yields and lower manufacturing costs.

[0061] In addition, as seen from Fig. 3 (A) and Fig. 3 (B), by equalizing threshold voltage V_{th1} and V_{th2} , the first effect where conductance control at each driving TFT 110 can be carried out by using higher gate voltage V_g than the voltage V_{sig} of input signals V_{sig} and the second effect where a variance in threshold voltage V_{th} among a plurality of transistor circuits 100 are clearly achieved; however, even without completely equalizing the threshold voltage V_{th1} of the driving TFT 110 and the threshold voltage V_{th2} of the compensating TFT 120 in each transistor circuit 100, both threshold voltages characteristically will offset each other, so that these first and second effects are achieved to some degree based on the similarity of both threshold voltages.

[0062] In this embodiment, particularly, it is constructed so as to supply reset signals V_{rsig} - having a voltage in response to a higher conductance than the maximum conductance controlled in response to input signals V_{sig} - to the gate 111. Therefore, it becomes possible to supply input signals V_{sig} to the gate 111 through the compensating TFT 120 that is connected to the gate 111 in an orientation to permit electric charge to move into a direction so as to lower this conductance after resetting, without being dependent on the level of voltage V_{sig} of input signals V_{sig} . Also, in this embodiment, reset signals V_{rsig} are set at a higher voltage than the maximum voltage of input signals V_{sig} by the threshold voltage V_{th2} level of the compensating TFT 120. Therefore, when input signals V_{sig} are input after resetting, voltage higher than the voltage V_{sig} of input signals V_{sig} only by the threshold voltage V_{th2} level of the compensating TFT 120 can always be supplied to the gate 111 without being dependent on the level of the voltage V_{sig} of input signals V_{sig} and the threshold voltage V_{th2} of the compensating TFT 120.

[0063] Moreover, when the inversion of input signals V_{sig} is carried out as frequently applied in conventional liquid crystal display elements, it is desirable that the above-noted reset signal V_{sig} relations are achieved in all input signals V_{sig} including inverse input signals.

[0064] The effects of these reset signals V_{rsig} by voltage setting are examined with reference to Fig. 4 and Fig. 5. Herein, Fig. 4 respectively shows the fluctuation of driving current relative to a variance ΔV_{th} of threshold voltage from a design standard level that is, for instance, -2.5V (1) when input signals V_{sig} are sup-

plied directly to the driving TFT 110 without the compensating TFT 120 (characteristic curve C1), (2) when input signals V_{sig} are supplied to the driving TFT 110 through the compensating TFT 120 at 5V of reset signal V_{rsig} (characteristic curve C2), and (3) when input signals V_{sig} are supplied to the driving TFT 110 through the compensating TFT 120 with reset signal V_{rsig} at 0V (characteristic curve C3). Also, Fig. 5 (A) shows the fluctuation range of gate voltage V_g corresponding to characteristic curve C2, and Fig. 5 (B) shows the fluctuation range of gate voltage V_g corresponding to characteristic curve C3. In addition, herein, V_{sig} is 7.5V; $+V_c$ is 10V; and $-V_c$ is 5V.

[0065] In Fig. 4, as indicated with characteristic curve C1, the variance ΔV_{th} of threshold voltage clearly appears directly as the variance of driving current I_d in the case of having no compensating TFT 120.

[0066] As illustrated with characteristic curve C2, when the compensating TFT is used at 5V of reset signal V_{rsig} , the variance ΔV_{th} of threshold voltage is significantly compensated on the plus side, but appears as the variance of driving current I_d at the minus side. This is because, as shown in Fig. 5 (A), on the minus side, gate voltage V_g cannot be made lower (or compensated) than input signals V_{sig} by the threshold voltage V_{th2} level to the negative voltage side, when input signals V_{sig} are input after resetting. This is because the compensating TFT 120 acting as diode can make gate voltage V_g closer to input signals V_{sig} from reset signals V_{rsig} but cannot do the opposite.

[0067] Also, as shown with characteristic curve C3, when the compensating TFT is used with 0V of reset signal V_{rsig} , the variance ΔV_{th} of threshold voltage hardly appears as the variance in driving I_d . This is because, as shown in Fig. 5 (B), gate voltage V_g can be made lower (or compensated) than input signals V_{sig} only by threshold voltage V_{th} level to the negative voltage side, when input signals V_{sig} are input after resetting. Moreover, if $V_{sig}=7.5V$ applied herein is considered as the minimum electric potential of input signals V_{sig} , the above-noted examination is realized to make sure that all V_{sig} can be compensated.

[0068] As described above, in this embodiment, without being dependent on the level of input voltage V_{sig} and threshold V_{th2} of the compensating TFT 110, voltage V_g that is lower than the voltage of the input signals V_{sig} only by the threshold voltage V_{th2} level of the compensating TFT 120 can be applied to the gate 111 of the driving TFT 110.

[0069] In addition, in Fig. 2 (A) and Fig. 2 (B), gate voltage V_g is held by the storage capacitor capacity 160 during the driving period. Therefore, by the storage capacitor 160, a variance in holding characteristics of gate voltage V_g among a plurality of transistor circuits 100 can be also reduced (compensated).

[0070] As explained with reference to Fig. 1 to Fig. 5, according to the transistor circuit 100 of this embodiment, the current-controlled element 500 such as an EL

element can be current-driven by input signals V_{sig} at a relatively low voltage; and moreover, without being dependent on a variance in voltage/current characteristics and threshold characteristics among a plurality of driving TFT 110, a plurality of current-controlled elements 500 can be current-controlled with good precision in accordance with the voltage of input signals V_{sig} .

[0071] Moreover, the example shown in Fig. 1 is constructed with the mixture of a P channel type TFT and an N channel type TFT; however, every TFT can be N channel type TFTs or all TFTs can be P channel type TFTs. However, in consideration that the voltage/current characteristics and threshold characteristics of the driving TFT 110 are compensated by the compensating TFT 120, it is advantageous to construct these driving TFT 110 and compensating TFT 120 by the same process as the same type TFT. Particularly, if both TFTs are formed in the same film forming process, the degree of characteristic similarities between both TFTs generally increases, so that it becomes possible to provide the transistor circuit 100 with little or no variance in voltage/current characteristics and threshold characteristics on the same substrate. On the other hand, the resetting TFT 130 and the switching TFT 140 can be either a P channel type or an N channel type without being dependent on whether the driving TFT 110 is a P channel type or N channel type. However, it is often advantageous in manufacturing when all TFTs are of the same type.

[0072] Also, each type of TFTs 110 - 140 in this embodiment may be any type of field effect transistor (FET) such as joining type, parallel/serial connection type, etc.

[0073] Furthermore, as shown in Fig. 6, the above-noted transistor circuit may consist of bipolar transistors. In this case, by corresponding the above-mentioned gate, source and drain to a base, an emitter and a collector respectively, a driving transistor 110' is constructed from a bipolar transistor, and at the same time, a compensating transistor 120' is constructed from a bipolar transistor, thus providing a transistor circuit 100'. Generally, in the case of bipolar transistors, the variance of threshold voltage with e.g., 0.7V as a center is smaller than that of TFTs; however, even if constructed as above, the effect of variance of voltage/current characteristics and threshold characteristics in the driving transistor 110' on driving current I_d can be compensated by the compensating transistor 120'. Furthermore, driving can be carried out by the driving transistor 110' at a relatively low voltage. Particularly, when the driving transistor 110' and the compensating transistor 120' are manufactured in the same manufacturing process, the degree of characteristic similarities between both transistors generally increases, so that it becomes possible to provide a plurality of transistor circuits 100' with little or reduced variance in voltage/current characteristics and threshold characteristics.

[0074] As the current-controlled element 500 in the embodiment mentioned above, various elements including current-controlled light-emitting elements such as an organic EL element and an inorganic EL element, a current-controlled heat transfer element, etc. are included.

(Display Panel)

[0075] The embodiments of a display panel of this invention is explained with reference to Fig. 7 to Fig. 10. Fig. 7 is a block diagram showing the entire structure of a display panel; Fig. 8 is a planar view of one picture element in the display panel; Fig. 9 (A), Fig. 9 (B) and Fig. 9 (C) are respectively a cross-sectional view on line A-A', a cross-sectional view on line B-B' and a cross sectional view on line C-C' thereof; and Fig. 10 is a circuit diagram of four picture elements adjoining each other.

[0076] The display panel in this embodiment includes the above-noted transistor circuits of this invention respectively and a plurality of picture elements arranged in a matrix form; and at the plurality of picture elements, EL elements 50 are arranged respectively as an example of current-controlled light-emitting elements.

[0077] As shown in Fig. 7, a display panel 200 has a TFT array substrate 1, a plurality of data lines 11 extending in the Y direction and arranged in the X direction in a picture display area wherein a plurality of picture elements 2 are arranged in a matrix condition on the TFT array substrate, a plurality of scanning lines 12 extending respectively in the X direction and arranged in the Y direction, and a plurality of common electric wires 13 arranged in parallel to the plurality of data lines 11. The display panel 1 further has a data line driving circuit 21 around the picture display area for supplying data signals to each data line 11, a pair of scanning line driving circuits 22 for supplying scanning signals to each scanning line 12, and an inspecting circuit 23 for inspecting continuity failure, insulation failure, defects of elements, etc. in each picture element 2. In addition, in this embodiment, each driving circuit is formed on the TFT array substrate 1 along with a picture element 2 in the same process, but it can be a circuit that is not formed on the TFT array substrate 1 or may be formed in a different process from the picture element 2.

[0078] As shown in Fig. 8, at each picture element 2, the driving TFT 110, the compensating TFT 120, the resetting TFT 130, the switching TFT 140 and the storage capacitor 160 that are explained above with reference to Fig. 1 to Fig. 6 are arranged. Moreover, a scanning line 12b in a previous stage becomes wiring for reset scanning signals V_{rscan} in Fig. 1; a scanning line 12a in this stage becomes wiring for scanning signals V_{scan} and for reset signals V_{rsig} in Fig. 1; and a data line 11a in this stage becomes wiring for input signals V_{sig} (data signals) in Fig. 1. Furthermore, the com-

mon electric wire 13 is connected to a positive power source +V; an EL element 50 is connected between the driving TFT 110 and a counter electrode mentioned later; and the counter electrode is connected to a negative power supply -V.

[0079] As shown in Fig. 9 (A), the switching TFT 140, the compensating TFT 120 and the storage capacitor 160, along an A-A' cross section in Fig. 8, consist of a semiconductor film (polysilicon film) 4 on the TFT array substrate 1, a gate insulating film 5 consisting of a silicon oxide film or a silicon nitride film, a Ta (tantalum) film 6, a first interlayer insulating film 7 consisting of a silicon oxide film or a silicon nitride film, and an Al film 8. In addition, instead of the Ta film for forming gate electrodes, a low-resistance polysilicon film may be formed.

[0080] More specifically, the switching TFT 140 is a top gate type TFT having a gate 141 made of polysilicon film 6, and is formed as an N channel type TFT having a semiconductor layer 4 counteracting the gate 141 through the gate insulating film 5 as a channel forming area and having a source 142 and a drain 143 that are doped at high concentration in the n type on both sides of the area. Also, the source 142 is connected to a data line 11a made of an Al film 8 through contact holes formed in the gate insulating film 5 and the first interlayer insulating film 7. Moreover, the drain 143 is connected to the compensating TFT 120 through contact holes formed in the gate insulating film 5 and the first interlayer insulating film 7 as well as the Al film 8.

[0081] The compensating TFT 120 is a top gate type TFT having a gate 121 made of a Ta film 6, and is formed as a P channel type TFT having a semiconductor film 4 counteracting the gate 141 through the gate insulating film 5 as a channel forming area and having a source 122 and a drain 123 that are doped at high concentration in the p type on both sides of the area. Also, the TFT is connected to the switching TFT 140, the storage capacitor 160 and the gate 111 of the driving TFT 110 through the contact holes formed in the gate insulating film 5 and the first interlayer insulating film 7 and the Al film 8.

[0082] In addition, the storage capacitor 160, so as to have a double capacitor structure, is formed in that the semiconductor film 4, the Ta film 6 and the Al film 8 are counterarranged through the gate insulating film 5 and the first interlayer insulating film 7. Also, the semiconductor film 4 constituting a storage capacitor is connected to the Al film 8 through the contact holes formed in the gate insulating film 5 and the first interlayer insulating film 7; and the Ta film 6 constituting a storage capacitor is connected to the Al film 8 through the contact holes formed in the first interlayer insulating film 7.

[0083] As shown in Fig. 9 (B), the resetting TFT 130, along a B-B' cross section in Fig. 8, consists of a semiconductor film 4, a gate insulating film 5, a Ta film 6, a first interlayer insulating film 7 and an Al film 8 on a TFT array substrate 1.

[0084] More specifically, the resetting TFT 130 is a

top gate type TFT having a gate 131 made of a Ta film 6, and is formed as an N channel type TFT having a semiconductor layer 4 facing the gate 131 through the gate insulating film 5 as a channel forming area and having a source 132 and a drain 133 that are doped at high concentration in the n type on both sides of the area. Also, the source 132 and the drain 133 are connected respectively to a scanning line 12a in this stage made of a Ta film 6 and the gate 111 of the driving TFT 110 through the contact holes formed in the gate insulating film 5 and the first interlayer insulating film 7 and the Al film 8.

[0085] Moreover, as shown in Fig. 9(C), the driving TFT 110, along a C-C' cross section in Fig. 8, consists of a semiconductor film 4, a gate insulating film 5, a Ta film 6, a first interlayer insulating film 7 and an Al film 8 on a TFT array substrate 1. Also, on a second interlayer insulating film 9, an ITO film 51 is formed that is connected to the drain 113 of the driving TFT 110 through contact holes and the Al film 8, and an EL element 50 is formed thereon. On the other hand, the source 112 of the driving TFT 110 is connected to a common electric wire 13 made of the Al film 8 through contact holes. Also, EL elements 50 at adjoining picture elements 2 are separated from each other by electrically insulating banks 52. Preferably, the banks have a shielding property. The banks 52 are made of, for instance, a shielding resist, and the bank 52 may be provided even at a peripheral parting area surrounding the picture display area of the display panel 200. In addition, on the EL element 50, a counter electrode (top electrode) 56 is arranged that is made of a low-resistance metal such as Al or ITO, etc.

[0086] As shown in Fig. 10, the display panel 200 particularly has a structure wherein positive power source +V is supplied to both picture elements 2 which are mutually adjoining in the X direction by the common electric wire 13; and compared with the case wherein power source wiring for supplying positive power source +V is simply provided for each of picture elements 2, the number of power source wiring is about 1/2. Moreover, having a structure wherein reset scanning signals Vrscan input to the gate 131 of the resetting TFT 130 are supplied by a scanning line 12b in the previous stage and reset signals Vrsig input to the resetting TFT 130 are supplied by a scanning line 12b in this stage, the number of signal wiring is reduced compared with the case wherein wiring only for reset scanning signals Vrscan and wiring only for reset signals Vrsig are provided. Therefore, without increasing the number of power source wiring and signal wiring, a space for the compensating TFT 120 and the resetting TFT 130 that is not provided in conventional display panels can be kept. There is no doubt that the ideas of this invention are applicable to the ones, different from this embodiment, wherein patterns are made the same for each picture element by providing a common electric wire per picture element or wherein wiring only for reset scan-

ning signals V_{rscan} and wiring only for reset signals V_{rsig} are provided.

[0087] In addition, in the case of the display panel 200 wherein the EL elements 50 are used as current-driven light-emitting elements as in this embodiment, unlike liquid crystal panels, etc., the panel emits its own light in response to the increase in electric current supplied to the light-emitting elements without increasing the hole area of picture elements, so that brightness necessary for picture image display can be obtained. Thus, as in this embodiment, it is possible to maintain a space for forming various TFTs in a picture element 2 by saving a wiring area, or a space for forming various TFTs in a picture element 2 may be kept by reducing the size of each EL element 50.

[0088] Next, the operation of the display panel 200 of this embodiment is explained with reference to Fig. 7 and Fig. 10.

[0089] When scanning signals V_{scan} are supplied to a scanning line 12b in a previous stage from a scanning line driving circuit 22, they are input to the gate 131 of the resetting TFT 130 in this stage as reset scanning signals V_{rscan} in this stage. At the same time, reset signals V_{rsig} are supplied from the scanning line driving circuit 22 to a scanning line 12a in this stage, and the gate voltage V_g of the driving TFT 110 in this stage becomes the electric potential of reset signals V_{rsig} (see Fig. 2 (A)). At this time, reset signals V_{rsig} may be the same as the OFF-state electric potential of scanning signals V_{scan} . When scanning signals V_{scan} are continuously supplied from the scanning line driving circuit 22 to the scanning line 12a in this stage, they are then input to the gate 141 of the switching TFT 140 in this stage. At the same time, input signals V_{sig} (data signals) are supplied from a data line driving circuit 21 to a data line 11a in this stage, and this voltage V_{sig} is lowered only by a threshold voltage V_{th2} of the compensating TFT 120 through the switching TFT 140 and the compensating TFT 120, and is then supplied as gate voltage V_g to the gate 111 of the driving TFT 110 in this stage (see Fig. 2 (A)). As a result, in response to this lowered gate voltage V_g , conductance between the source 112 and the drain 113 of the driving TFT 110, and driving current I_d flowing to the EL element 50 is then controlled between positive power source $+V$ and negative power source $-V$.

[0090] Therefore, a variance in threshold voltage V_{th1} of the driving TFT 110 at each picture element 2 is compensated by a threshold V_{th2} of the compensating TFT 120, and the variance in thresholds of data signals V_{sig} in response to driving current I_d among a plurality of picture elements 2 is almost gone, so that even picture images are displayed with even brightness over the entire picture display area of the display panel 200. It is also possible to control driving current I_d with data signals V_{sig} having a relatively small voltage due to the step-down voltage operation of the compensating TFT 120.

[0091] In the above-noted embodiment, gate voltage V_g is reset by the resetting TFT 130 before input signals V_{sig} are supplied; however, for instance, in the display period of a static picture, the control of driving current I_d can be carried out over a plurality of frames by the same input signals V_{sig} , so that it is unnecessary to carry out resetting operations for each scanning. Also, instead of these electrically reset signals V_{rsig} , gate voltage V_g may be reset (to be a predetermined reset voltage) by light irradiation. Furthermore, instead of the resetting TFT 130, reset signals V_{rsig} may be supplied through the switching TFT 140 and the compensating TFT 120. On the other hand, of course, the switching TFT 140 and switching operations will be unnecessary if switching such as active matrix driving is not carried out.

(Electronic Apparatus)

[0092] Next, the electronic apparatus of the embodiment having the display panel 200 which was explained above in detail will be explained with reference to Fig. 11 to Fig. 13.

[0093] First, Fig. 11 shows the schematic structure of an electronic apparatus having the display panel 200 as mentioned above.

[0094] In Fig. 11, the electronic device includes a display information output source 1000, a display information processing circuit 1002, a driving circuit 1004, a display panel 1006, a clock generating circuit 1008 and a power source circuit 1010.

[0095] The display panel 200 in the above-noted embodiment is equivalent to the display panel 1006 and the driving circuit 1004 in this embodiment. Therefore, the driving circuit may be installed on a TFT array substrate of the display panel 1006, and moreover, the display information processing circuit 1002, etc. may be installed. Or, the driving circuit 1004 may be fixed externally onto a TFT array substrate on which the display panel 1006 is installed.

[0096] The display information output source 1000 includes a memory such as ROM (Read Only Memory), RAM (Random Access Memory) and an optical disk device, a tuning circuit for tuning television signals and then outputting, etc.; and based on clock signals from the clock generating circuit 1008, display information such as the picture image signals of a predetermined format is output to the display information processing circuit 1002. The display information processing circuit 1002 includes various conventional processing circuits such as an amplifying/inversion circuit, a phase developing circuit, a rotation circuit, a gamma control circuit and a clamp circuit; and digital signals are sequentially formed from display information that is input based on clock signals and are then output to the driving circuit 1004 along with clock signals CLK. The driving circuit 1004 drives the display panel 1006. The power source circuit 1010 supplies a predetermined power source to

each circuit mentioned above.

[0097] Next, the specific examples of the electronic apparatus prepared as above are shown respectively in Fig. 12 and Fig. 13.

[0098] In Fig. 12, as another example of the electronic apparatus, a multimedia laptop personal computer (PC) 1200 has the above-noted display panel 200 in a top cover case 1206, and further includes a main body 1204 having a CPU, a memory, a modem, etc. and a built-in keyboard 1202.

[0099] Also, as shown in Fig. 13, in the case of a display panel 1304 with no built-in driving circuit 1004 and display information processing circuit 1002, an IC1324 containing the driving circuit 1004 and the display information processing circuit 1002 is physically and electrically connected to a TCP (Tape Carrier Package) 1320 through an anisotropic conductive film arranged at the periphery of the TFT array substrate 1, and can be manufactured, sold, used, etc. as a display panel.

[0100] As explained above, according to this embodiment, various electronic apparatuses are provided that can be driven at a relatively low voltage and with little unevenness in brightness over the entire surface of a display panel.

[0101] According to the transistor circuits of this invention, gate voltage can be reduced or increased relative to the voltage of input signals only by a threshold voltage of a compensating transistor, so that conductance control in the driving transistor can be carried out by a lower voltage of input signals. Moreover, by making the threshold characteristics and voltage/current characteristics of a compensating transistor and a driving transistor similar, the threshold voltage of input signals to driving current can become near zero. Furthermore, in the case a plurality of the transistor circuits is prepared by applying a plurality of driving transistors with different threshold characteristics, even if a plurality of driving transistors with many different threshold voltages is applied - in other words, a plurality of driving transistors having various threshold voltages relative to a design standard level - it is also possible to provide a plurality of transistor circuits with almost no or no variance at all in threshold voltage in the plurality of transistor circuits.

[0102] According to the display panel of this invention, picture image display with reduced unevenness in brightness is achieved by applying low voltage input signals.

Industrial Applicability

[0103] A display panel is provided that can display picture images with reduced unevenness of brightness, from the transistor circuits of this invention; and the display panel is useful for electronic devices such as laptop personal computers (PC), televisions, view finder or monitor display-type video tape recorders, car naviga-

tion devices, electronic notebooks, calculators, word processors, engineering workstations (EWS), cellular phones, TV telephones, POS terminals, pagers, devices with touch panels, and the like.

Claims

1. A transistor circuit comprising a driving transistor including a first gate, a first source and a first drain wherein conductance between the first source and first drain is controlled in response to voltage of input signals supplied to the first gate, and a compensating transistor including a second gate, a second source and a second drain wherein the second gate is connected to one of the second source and second drain and wherein the compensating transistor is connected to the first gate in an orientation so as to supply the input signals to the first gate through the second source and second drain, and to permit the first gate to move electric charge into a direction to lower the conductance.
2. The transistor circuit according to Claim 1, further comprising a resetting means for supplying reset signals - having voltage giving a level of conductance that is higher than a maximum level of the conductance controlled in response to the input signals - to the first gate before the input signals are supplied.
3. The transistor circuit according to Claim 2, wherein the reset signals are set to a voltage higher than a maximum voltage of the input signals by a threshold voltage level of the compensating transistor.
4. The transistor circuit according to Claim 2 or Claim 3, wherein the resetting means comprises a resetting transistor including a third gate, a third source and a third drain wherein one of the third source and third drain is connected to the first gate, and wherein the reset signals are supplied to the first gate through the third source and third drain when reset timing signals are supplied to the third gate before the supply of the input signals.
5. The transistor circuit according to any of Claims 1, 2, 3 and 4, wherein the driving transistor and the compensating transistor are the same type of transistors.
6. The transistor circuit according to any of Claims 1, 2, 3, 4 and 5, further comprising a switching transistor that includes a fourth gate, a fourth source and a fourth drain and that are connected so as to supply the input signals to the compensating transistor through the fourth source and fourth drain when switching timing signals are supplied to the fourth gate.

7. The transistor circuit according to any of Claims 1, 2, 3, 4, 5 and 6, further comprising a storage capacitor connected to the first gate.
8. The transistor circuit according to any of Claims 1, 2, 3, 4, 5, 6 and 7, wherein the transistors are respectively thin-film transistors formed on the same substrate. 5
9. The transistor circuit according to any of Claims 1, 2, 3, 4, 5, 6 and 7, wherein the transistors are respectively bipolar transistors wherein the gate, source and drain correspond to a base, an emitter and a collector respectively. 10
10. The transistor circuit according to any of Claims 1, 2, 3, 4, 5, 6, 7, 8 and 9, wherein the input signals are voltage signals where voltage is controlled by an input signal source, wherein the driving transistor has one of the first source and first drain connected to a current-controlled element and controls electric current flowing to the current-controlled element by controlling the conductance. 15 20
11. A display panel comprising the transistor circuits of Claim 10 respectively and a plurality of picture elements arranged in a matrix condition, wherein current-controlled light-emitting elements are applied respectively to the plurality of picture elements as the current-controlled elements. 25 30
12. An electronic apparatus, comprising the display panel of Claim 11. 35

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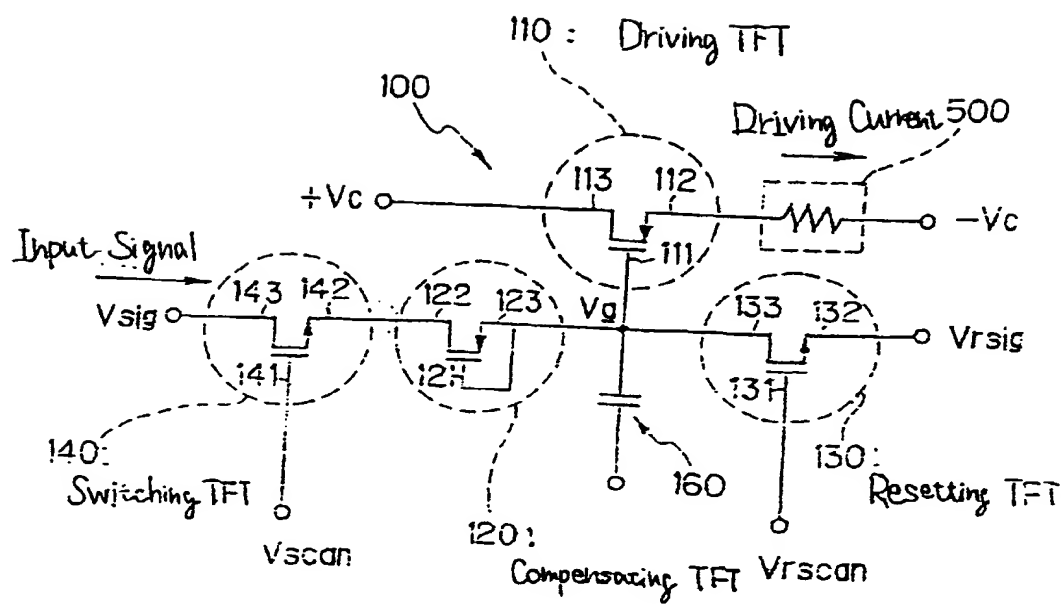


Fig. 1

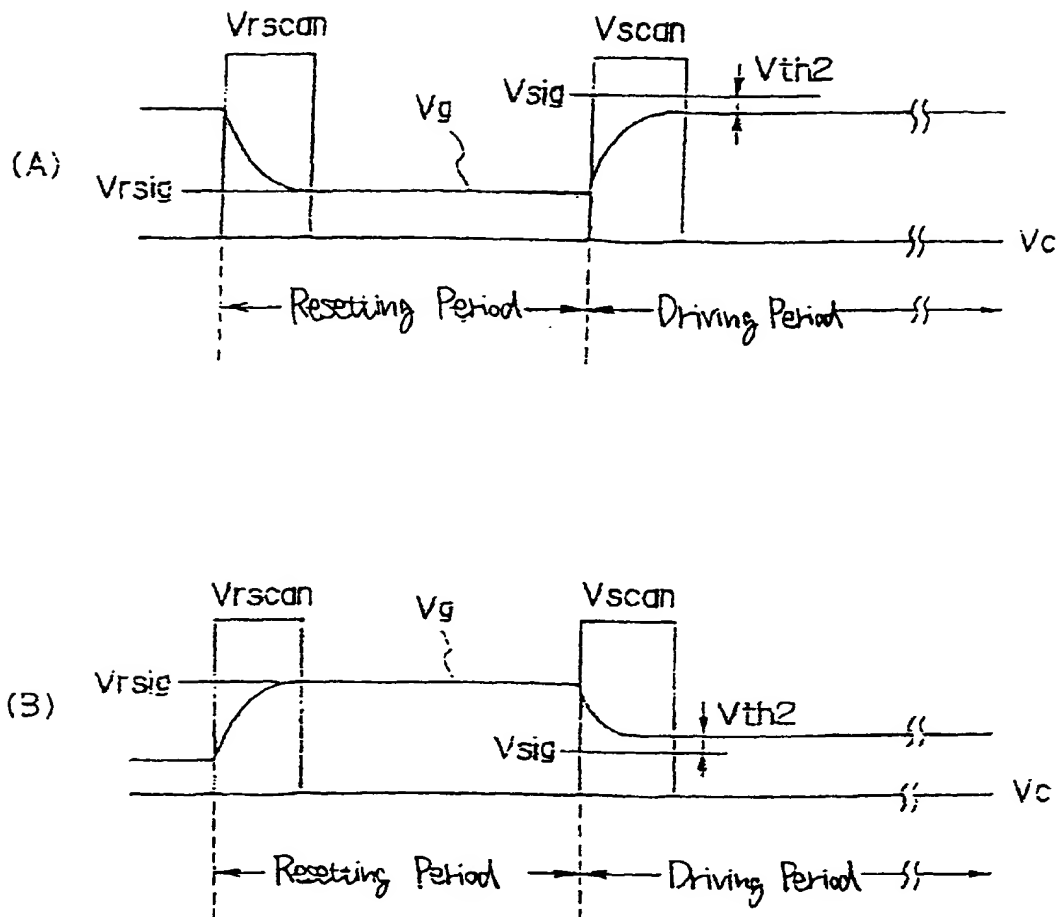
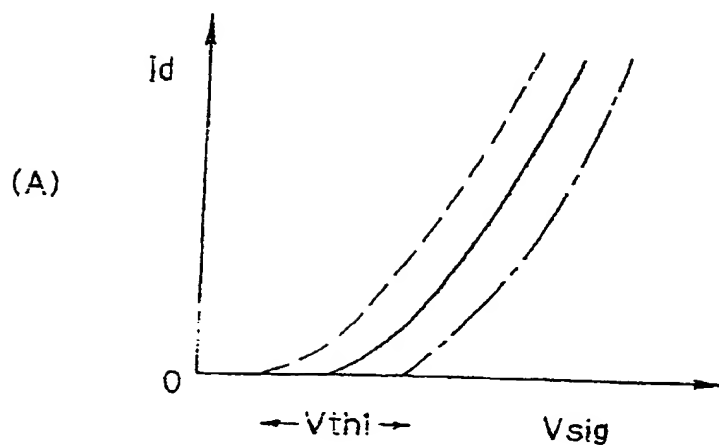


Fig. 2

Case of Using only a Driving TFT (Comparative)



Case of Using a Driving TFT and a Compensating TF
(Embodiment of the Invention)

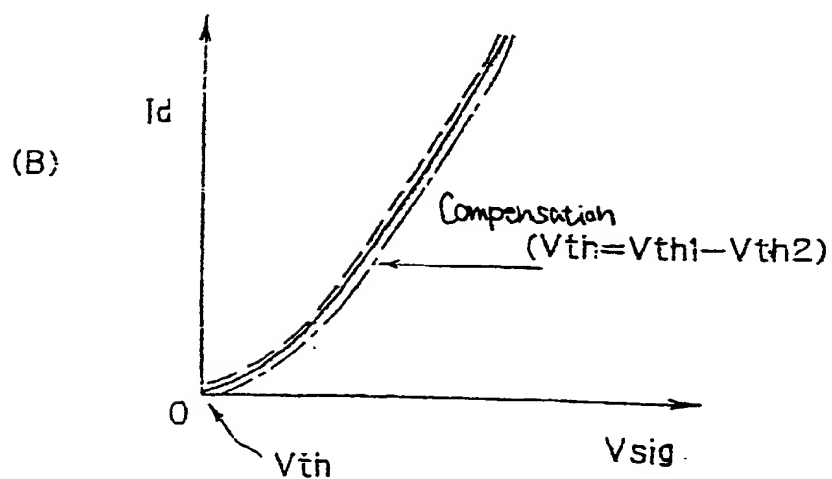


Fig. 3

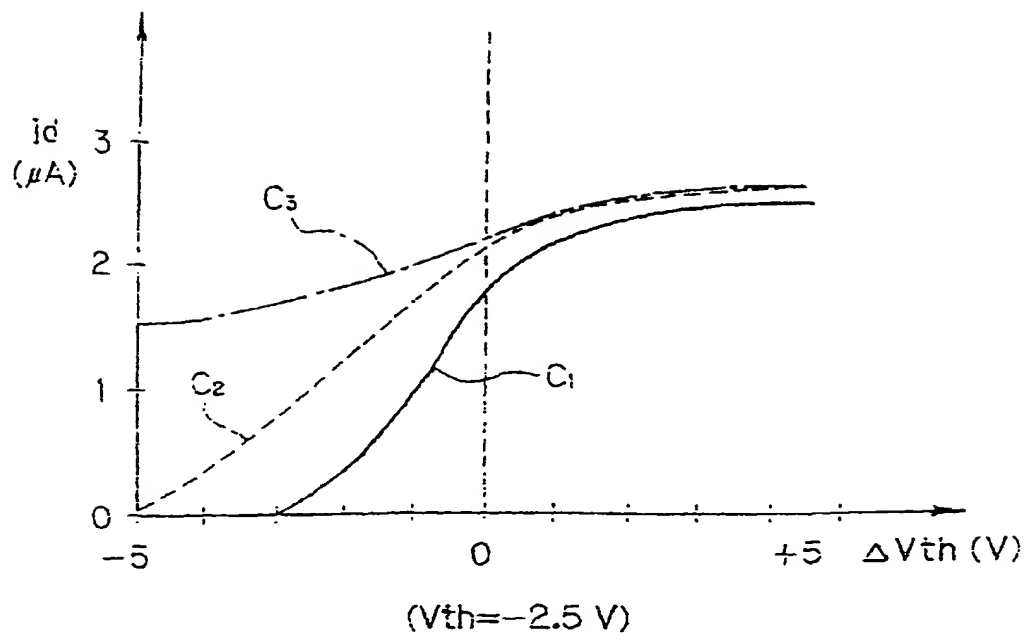


Fig. 4

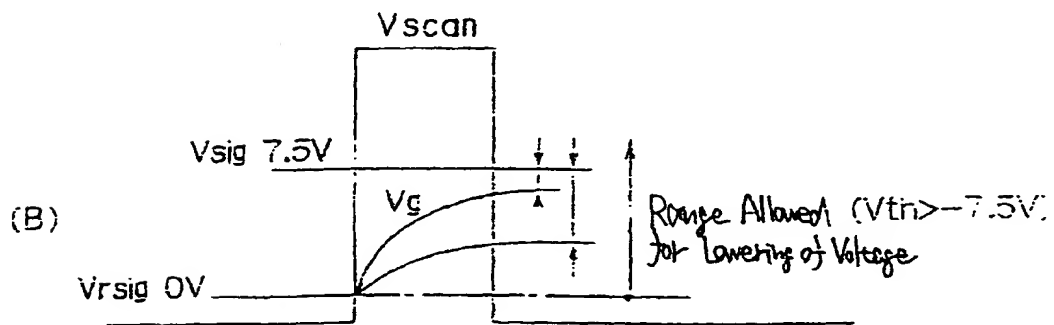
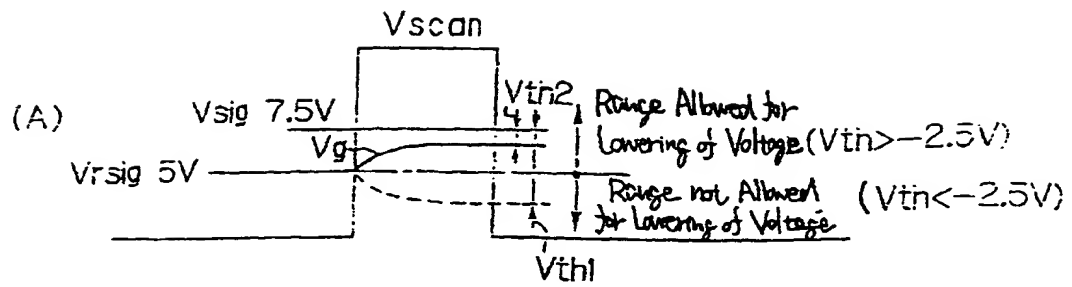


Fig. 5

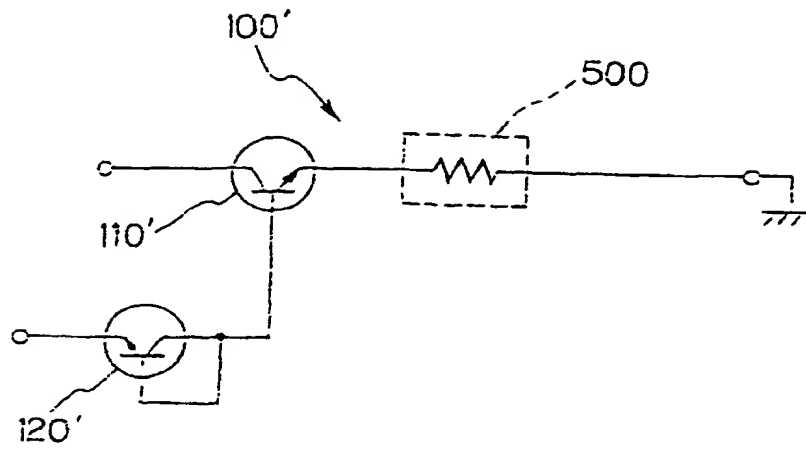


Fig. 6

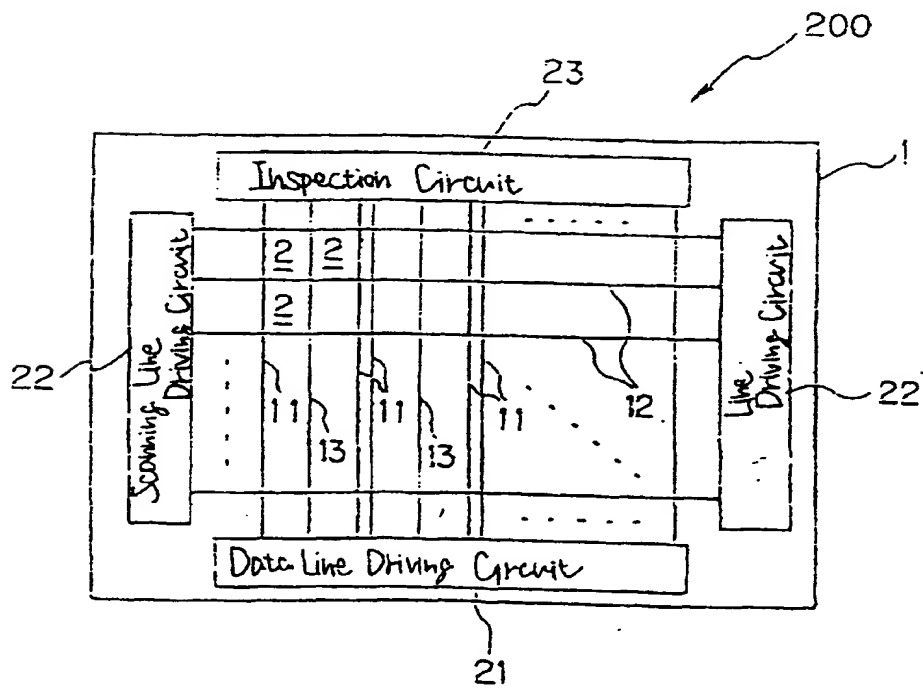


Fig. 7

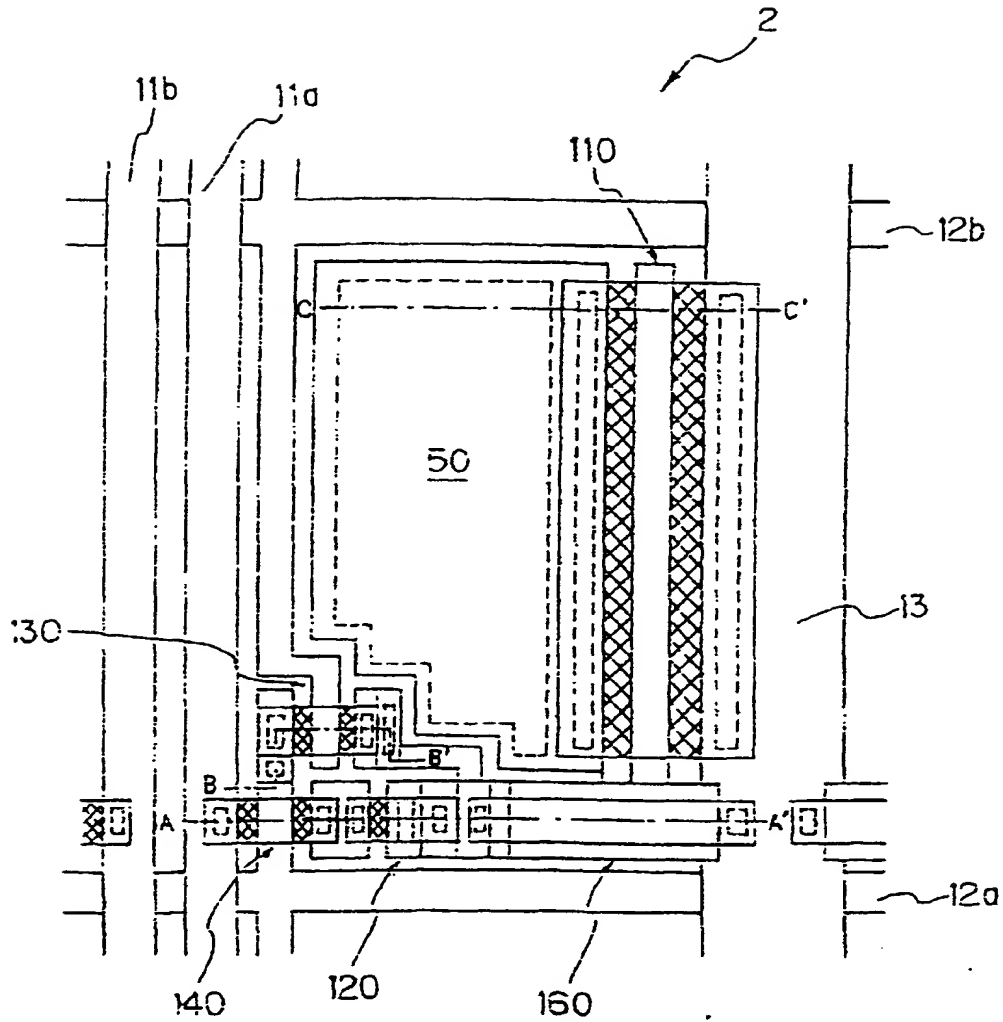


Fig. 8

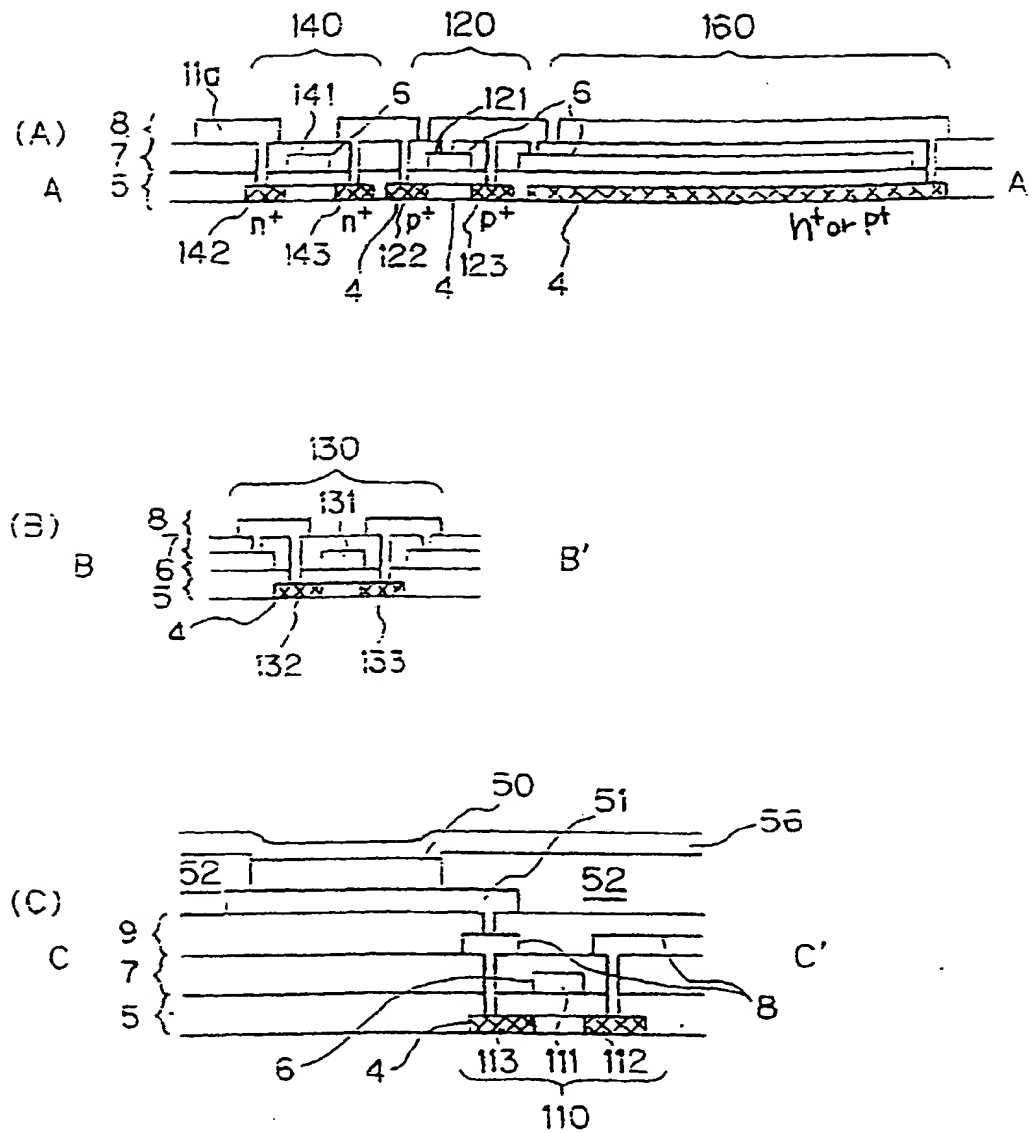


Fig. 9

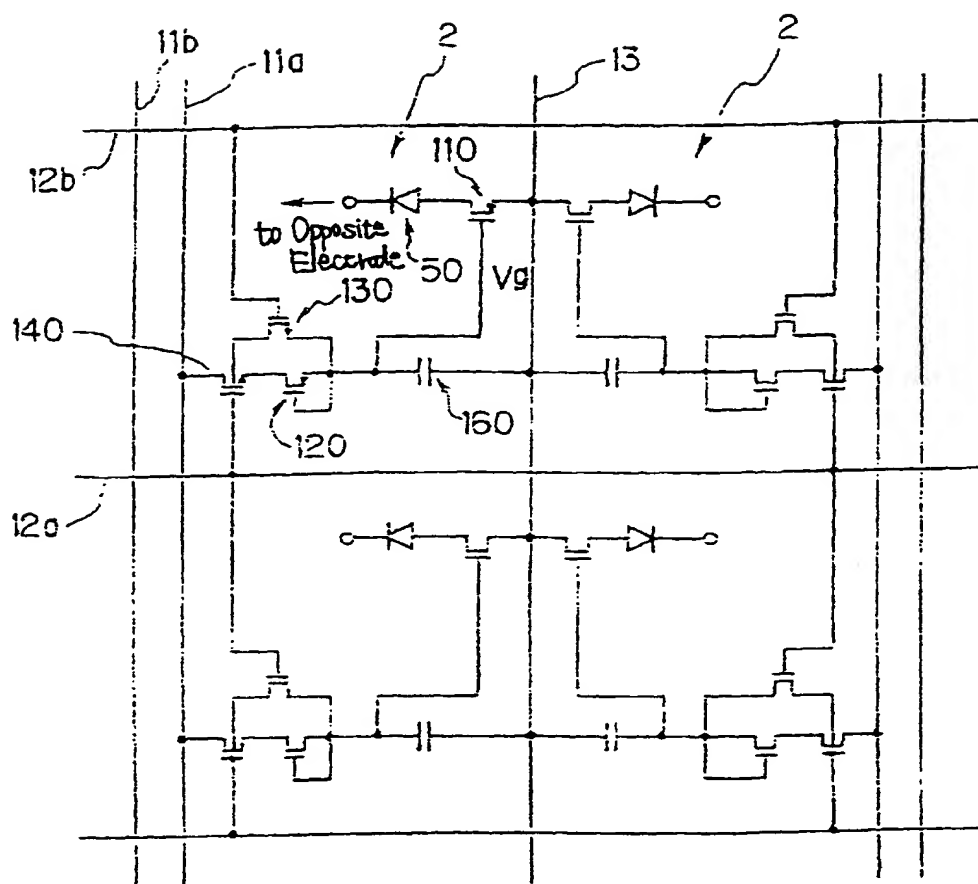


Fig. 10

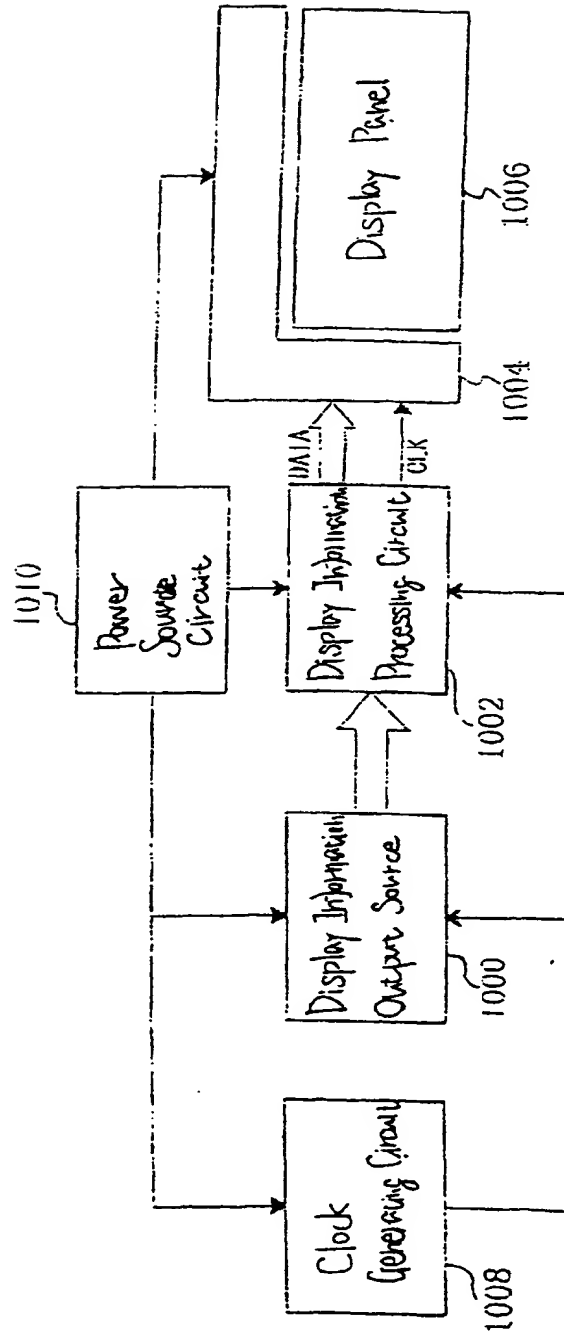


Fig. 11

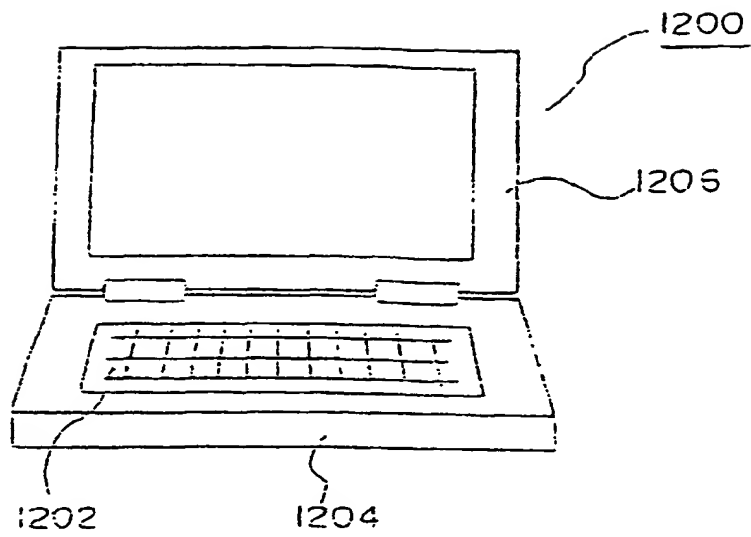


Fig. 12

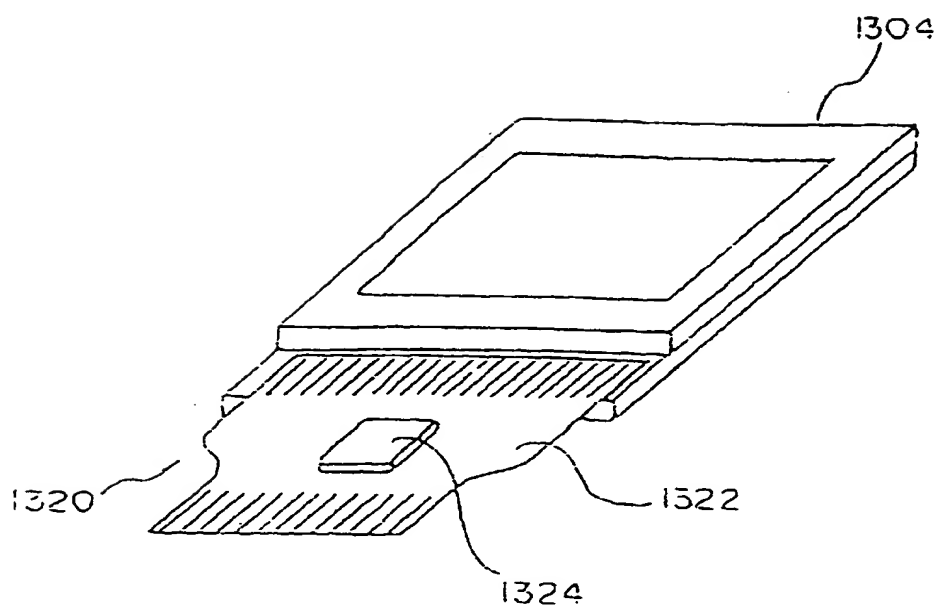


Fig. 13

INTERNATIONAL SEARCH REPORT

International application No.

PCT/JP99/01342

A. CLASSIFICATION OF SUBJECT MATTER Int.Cl. ⁶ G09G3/30, 3/36, H03K17/30 According to International Patent Classification (IPC) or to both national classification and IPC		
B. FIELDS SEARCHED Minimum documentation searched (classification system followed by classification symbols) Int.Cl. ⁶ G09G3/30, 3/36, H03K17/30 Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched Jitsuyo Shinan Koho 1922-1996 Toroku Jitsuyo Shinan Koho 1994-1999 Kokai Jitsuyo Shinan Koho 1971-1999 Jitsuyo Shinan Toroku Koho 1996-1999 Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)		
C. DOCUMENTS CONSIDERED TO BE RELEVANT		
Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	JP, 61-201315, A (Hitachi, Ltd.), 6 September, 1986 (06. 09. 86), Full text ; Fig. 1	1, 5, 8, 10
Y	Full text ; Fig. 1	11, 12
A	Full text ; Fig. 1 & US, 4642552, A	2-4, 6-7, 9
A	JP, 64-39757, A (NEC Corp.), 10 February, 1989 (10. 02. 89), Full text ; Figs. 1 to 4 (Family: none)	1-12
A	JP, 2-32615, A (Toshiba Corp.), 2 February, 1990 (02. 02. 90), Full text ; Fig. 1 & EP, 351874, A	1-12
A	JP, 5-343924, A (Sanyo Electric Co., Ltd.), 24 December, 1993 (24. 12. 93), Full text ; Figs. 1 to 3 (Family: none)	1-12
<input checked="" type="checkbox"/> Further documents are listed in the continuation of Box C. <input type="checkbox"/> See patent family annex.		
* Special categories of cited documents: "A" document defining the general state of the art which is not considered to be of particular relevance "E" earlier document but published on or after the international filing date "L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified) "O" document referring to an oral disclosure, use, exhibition or other means "P" document published prior to the international filing date but later than the priority date claimed	"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention "X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone "Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combinations being obvious to a person skilled in the art "Z" document member of the same patent family	
Date of the actual completion of the international search 14 May, 1999 (14. 05. 99)		Date of mailing of the international search report 22 June, 1999 (22. 06. 99)
Name and mailing address of the ISA/ Japanese Patent Office		Authorized officer
Facsimile No.		Telephone No.

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